

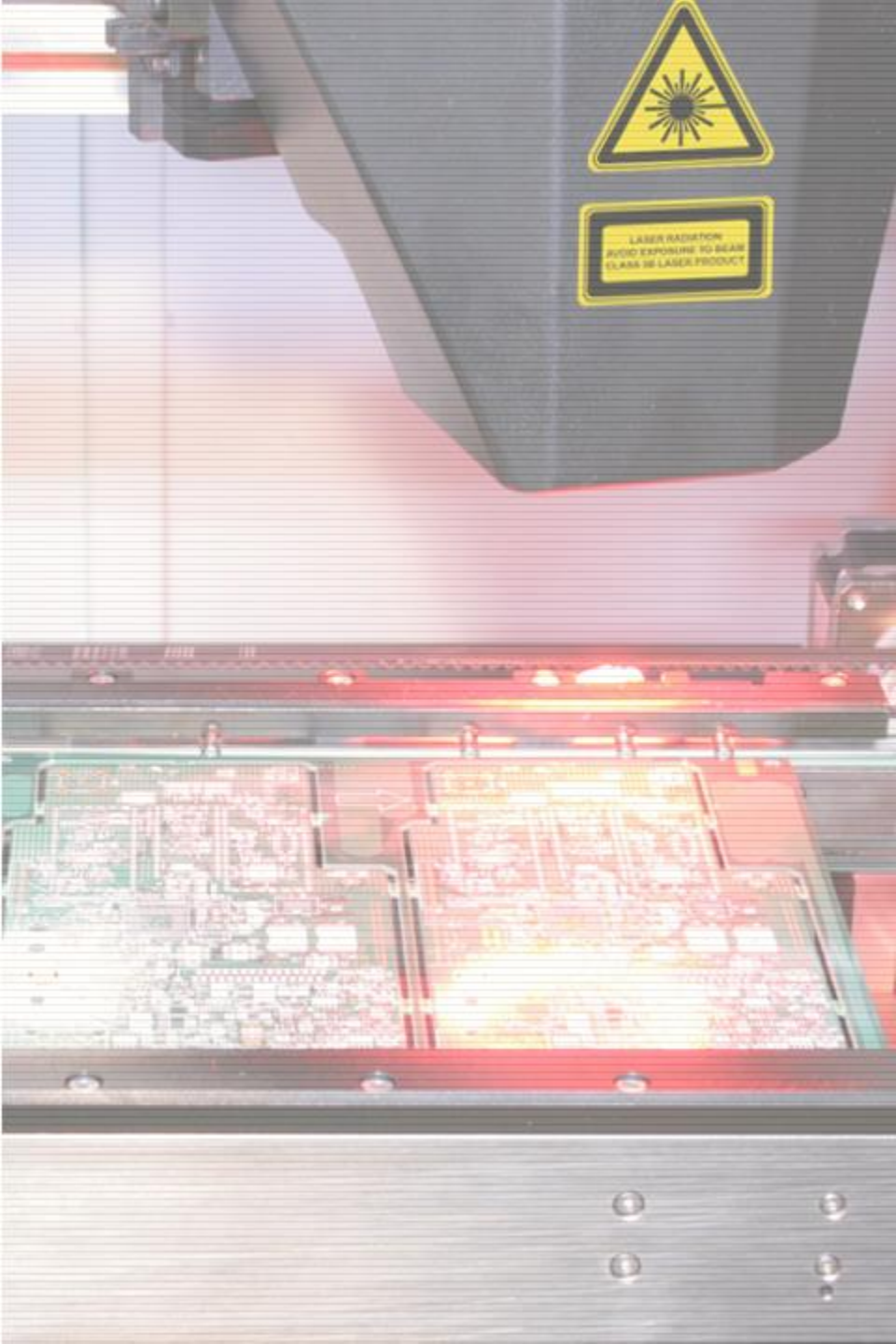


OVERVIEW

SPI 50T

Feb. 2009

PARMI



INTRODUCTION

SPI 50T System

The major roles of the system

Customer's benefits



SPI 50T System

- The genius table top 3D SPI machine
- Detect Every kind of Defects
- Excellent Repeatability
- High Performance
 - The most actual and accurate
 - Utmost fast : 100 % inspection
 - The most reliable





Major Roles



Detecting faulty solder paste locations with “zero” false calls

- Volume, Height, Area, Positional Offset, Bridge, Shape



Monitoring the current printing process

- Helps operator to know printing status quickly at production lines

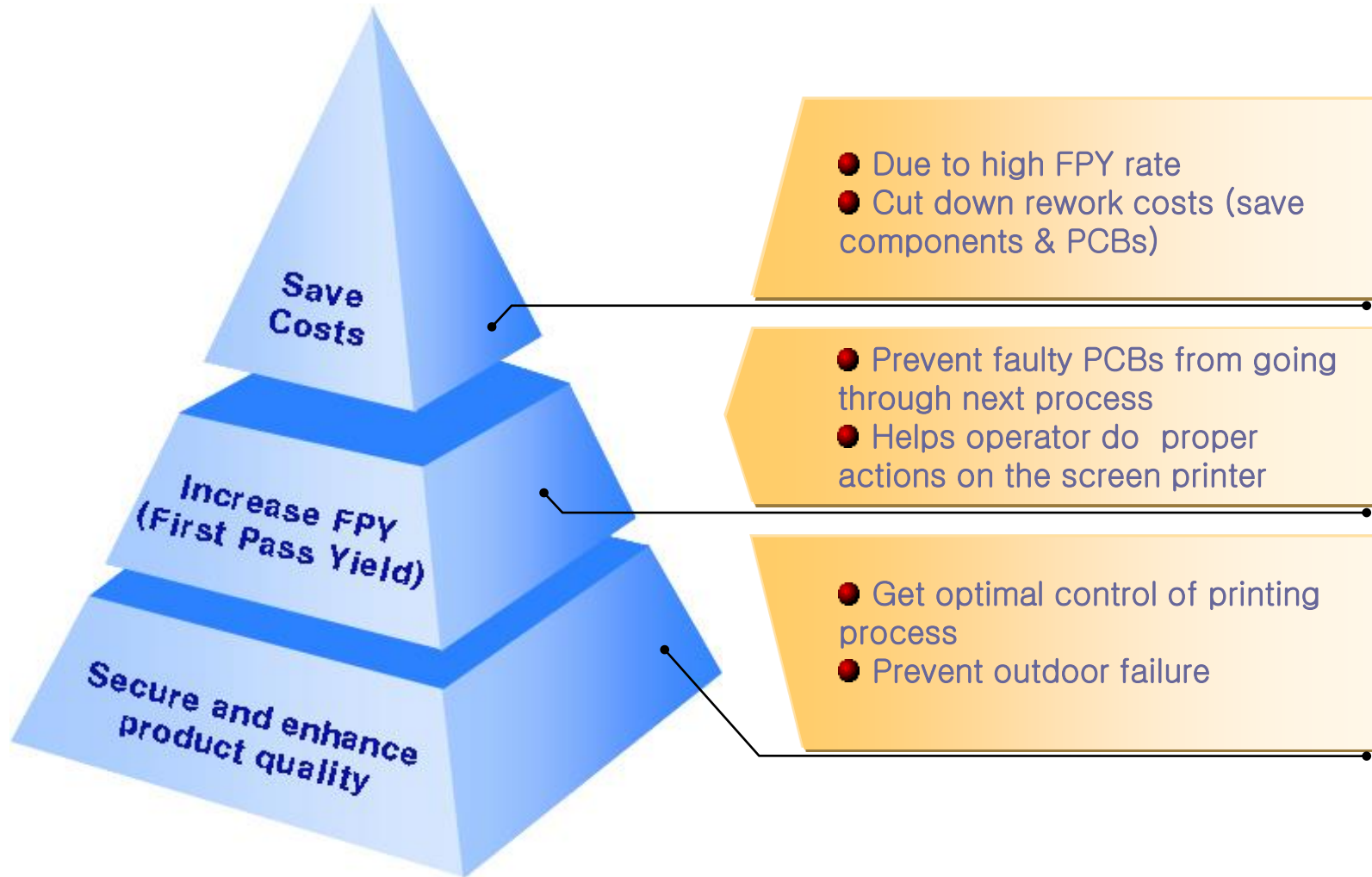


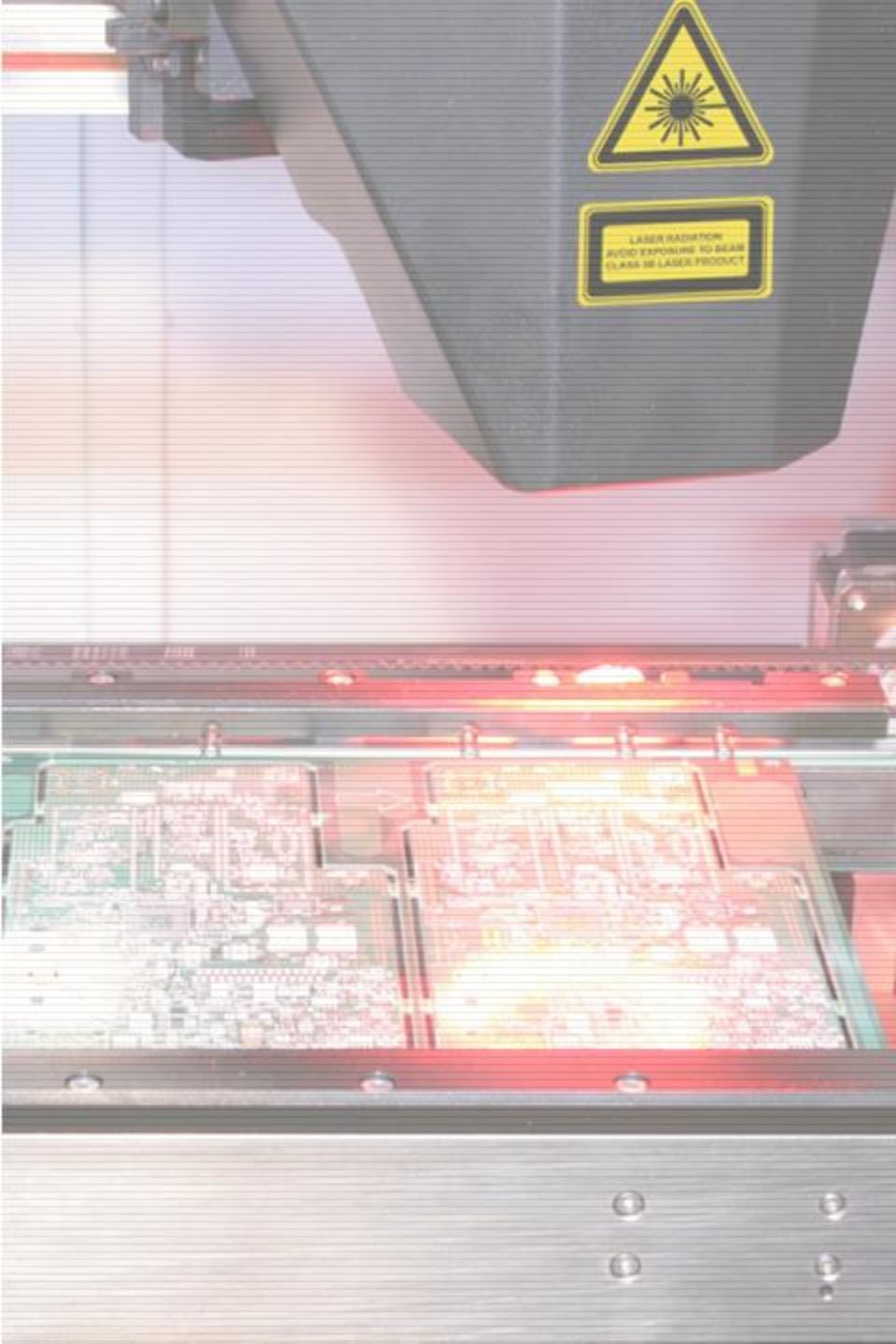
SPC (Statistical process control)

- Classical printing process monitoring & control functions
- Anyone can have network connection to a machine DB for SPC
- Real time monitoring & analysis



Customer's Benefits





HARDWARE

Dimension

Hardware Schematics

Hardware Configuration

X-Y Robot

PCB Guide Unit

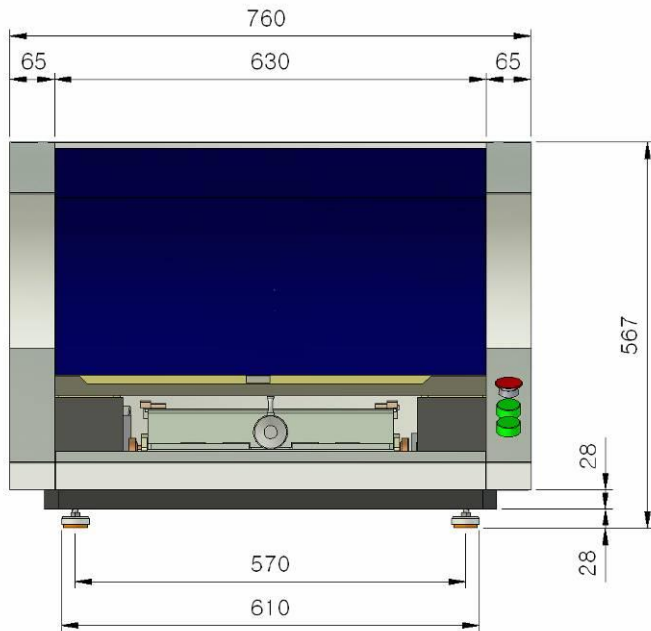
Control System

Interface

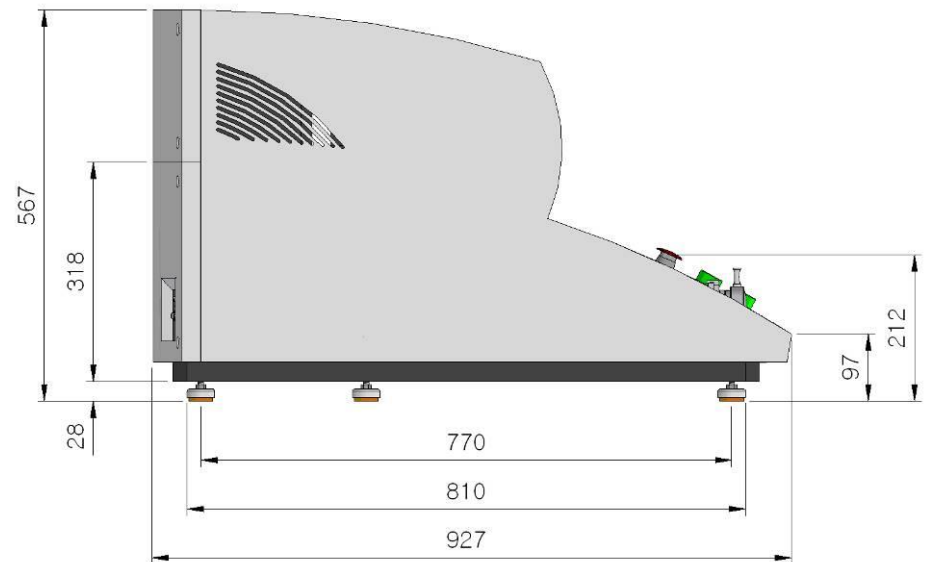


Dimension

FRONT

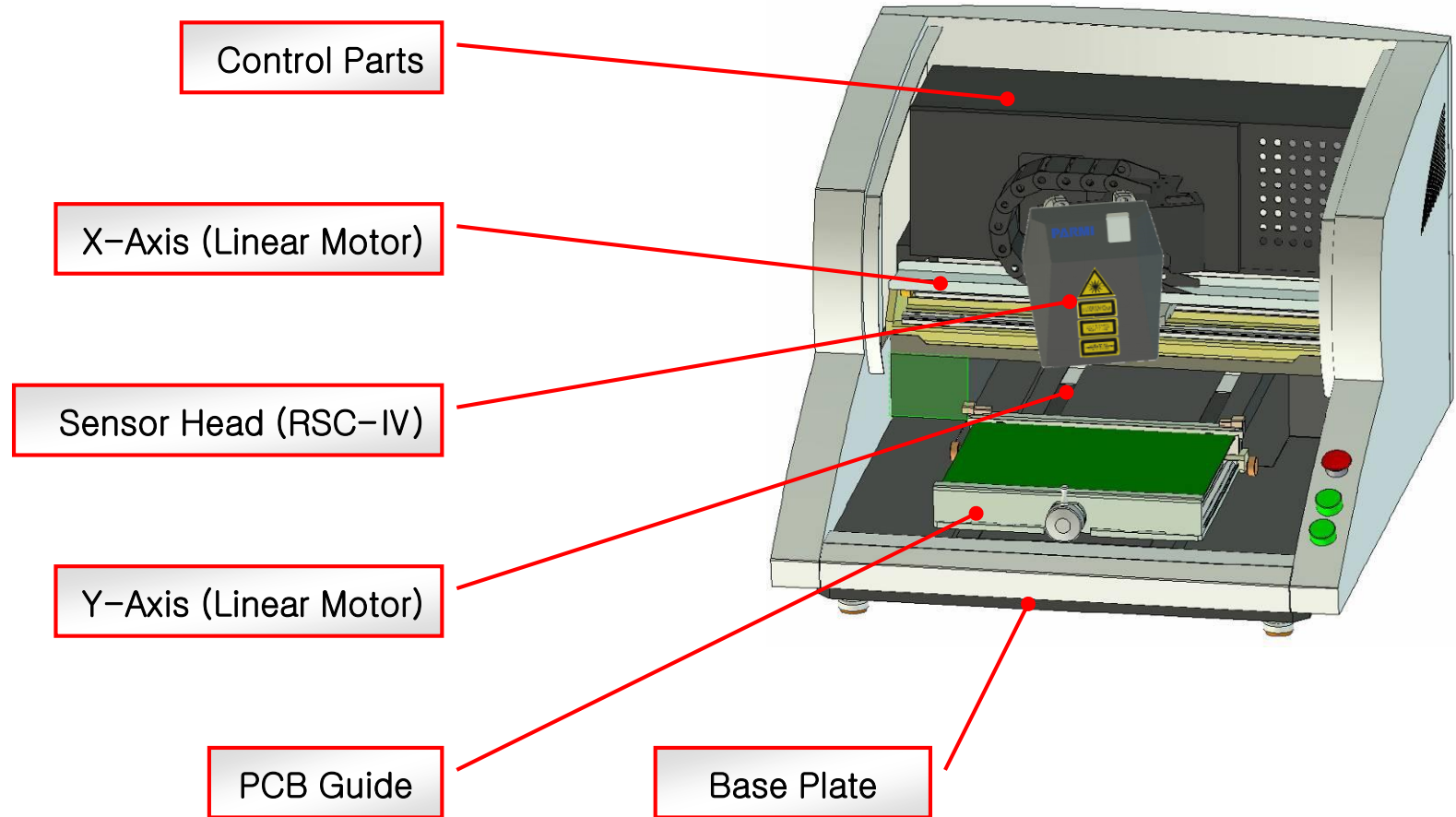


SIDE





Hardware Schematics





Hardware Configuration

- **Base Frame**
 - Made of aluminum casting, Rigid and vibration resistant
- **X-Y robot**
 - Linear Motor ensure stable measuring
- **PCB Guide Unit**
 - Easy Operation for board handling
- **Control System**
 - Controls all the actuators and 3D data process
- **Interface**
 - Connecting the machine and control system(PC)
- **3D Sensor**
 - Get 3D image for measurement, 2D image for fiducial mark



X-Y Robot

- X & Y stages driven by linear motors
- High positional accuracy and repeatability
- X-stage moves the 3D sensor to obtain 3D & 2D images
- Y-stage moves the panel

X axis



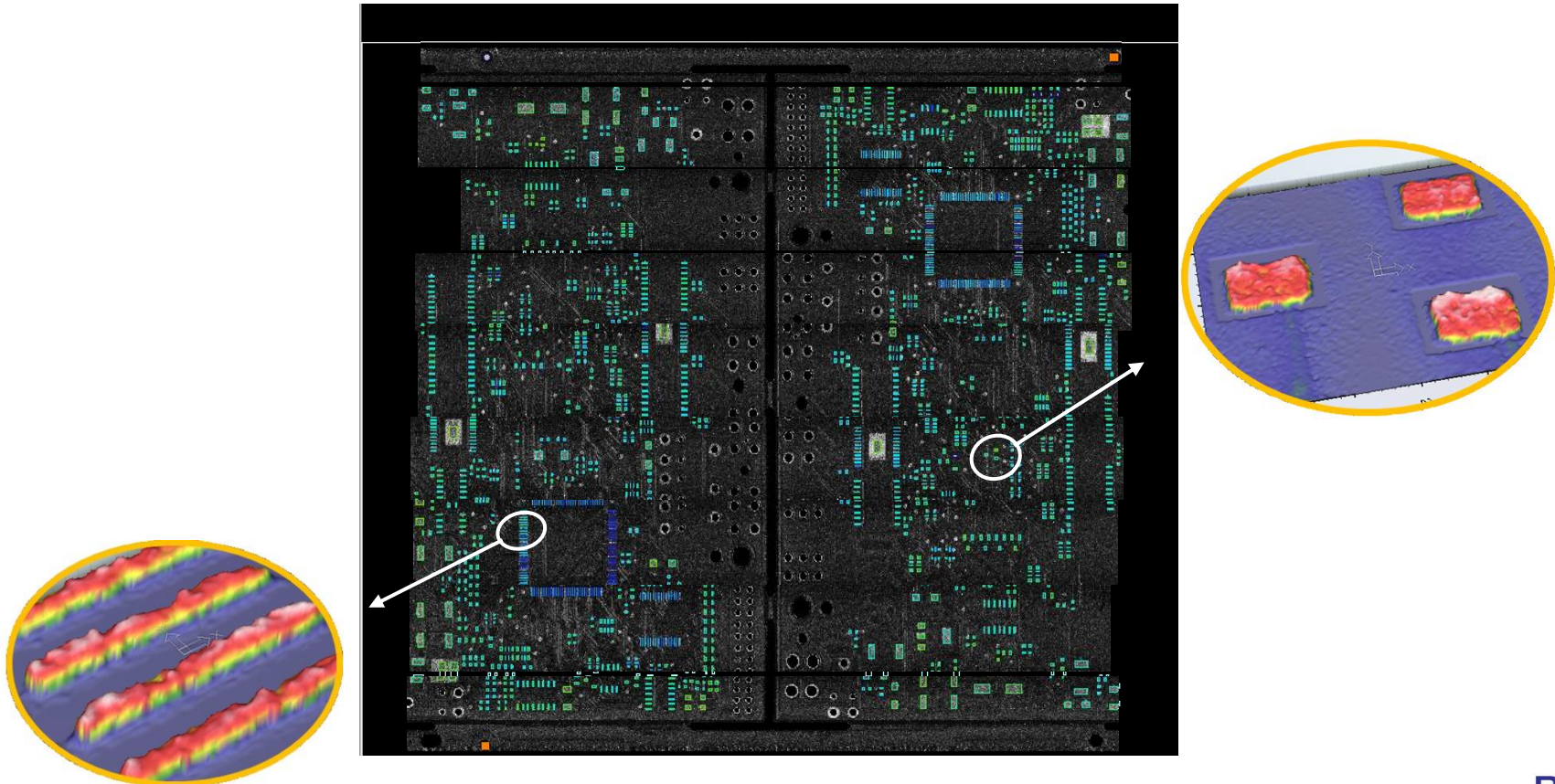
Y axis





X-Y Robot

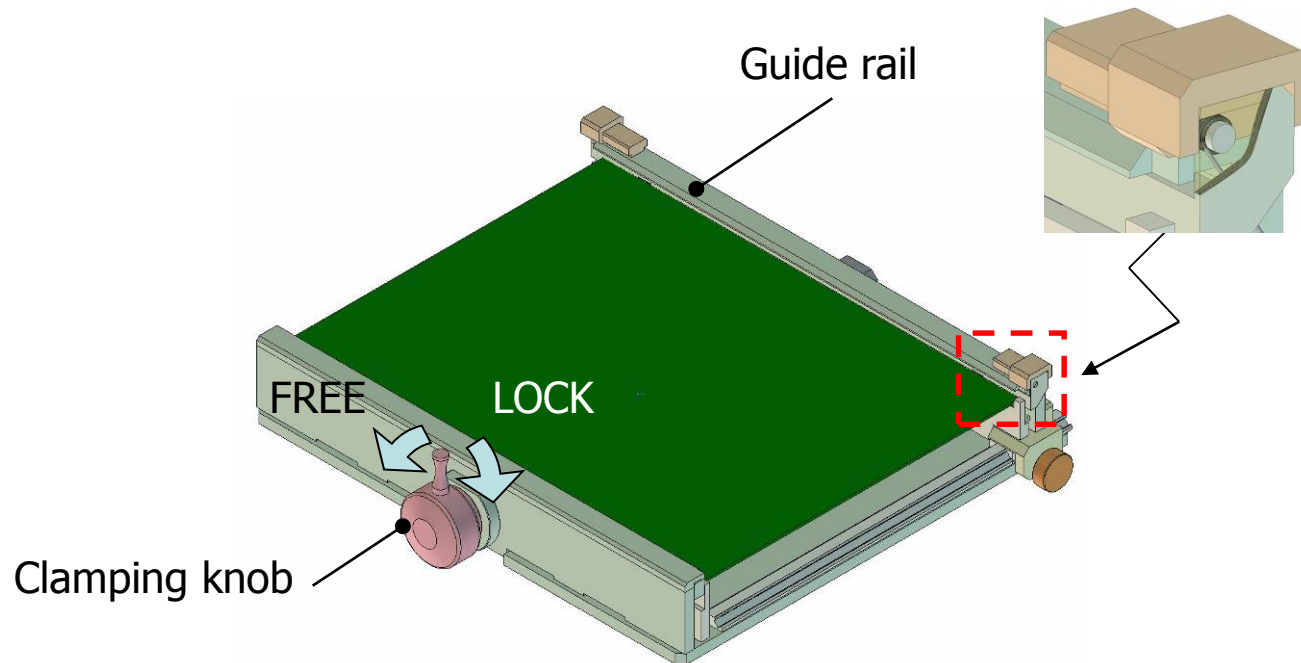
- Zigzag scanning panels
 - Smooth operation with a constant speed
 - More stable than other machines or methods requesting abrupt several go & stop movements every second





PCB Guide Unit

- Mounting PCBs Manually
- Adjusting width
- Clamping PCBs by turning the knob



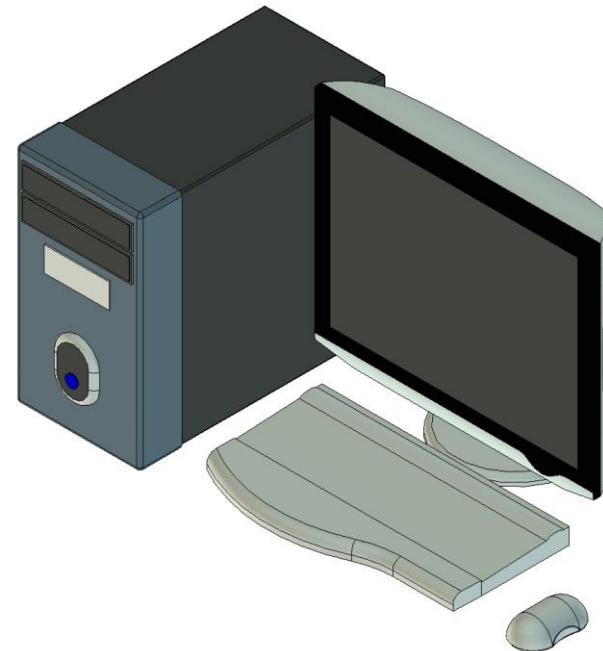


Control System

- PC system controls entire machine operation
- Controls X-Y robot
- Sensor signal input and image processing
- Measuring, defect detection, and data save
- User Interface : Buttons, Keyboard, mouse, 17" monitor

Specification

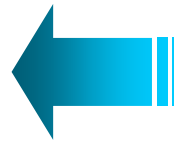
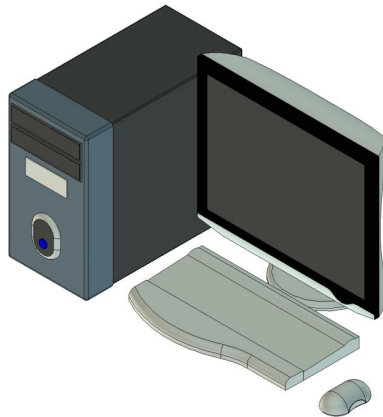
CPU	Pentium Core II Duo Processor
RAM	4 GB
HDD	160 GB
VGA	64MB or 128MB
O/S	Windows XP Professional
DISPLAY	17" LCD

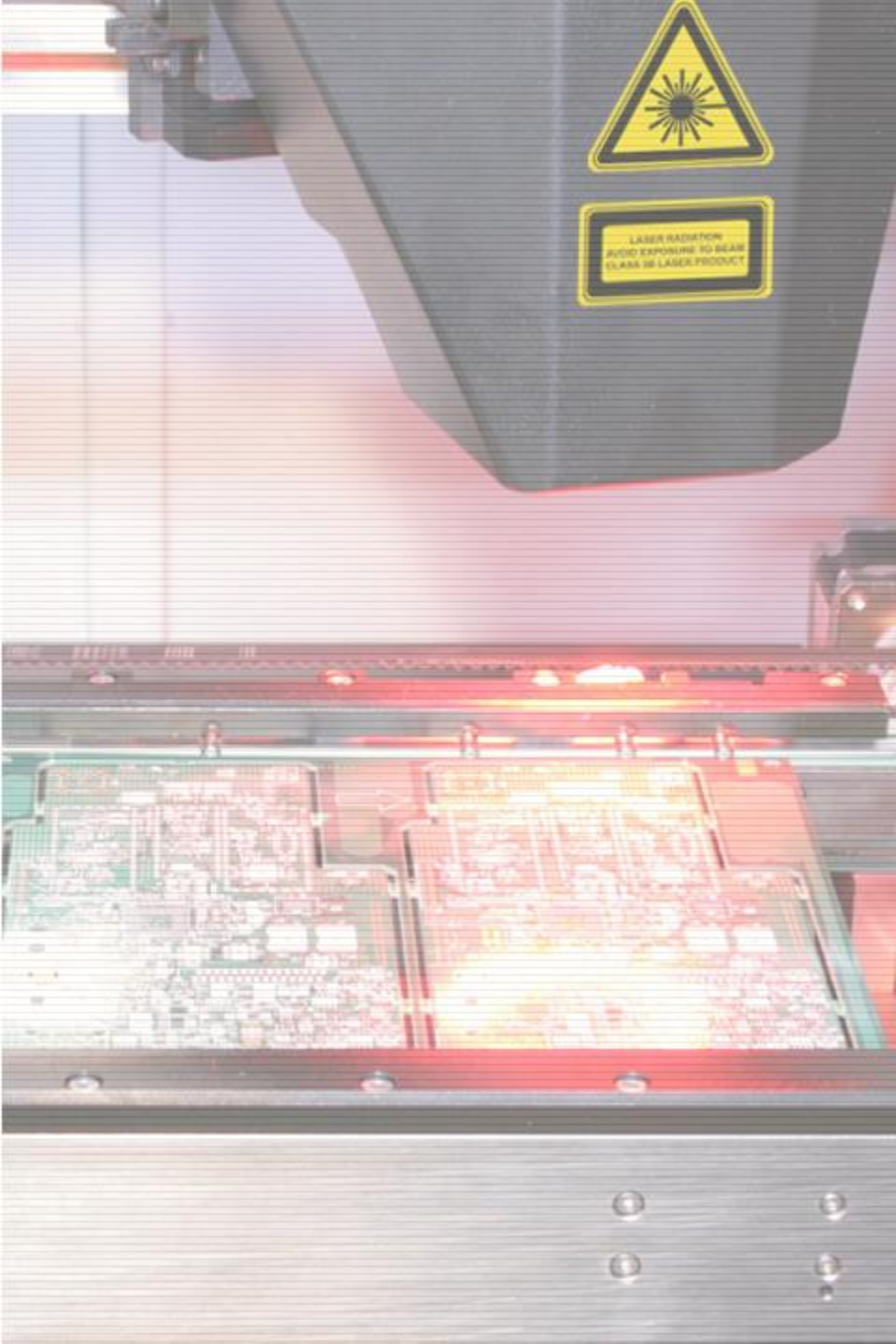




Interface

- Motion Control Cable
- I/O Control Cable
- Camera Link Cable
- Trigger Cable





3D SENSOR

RSC IV

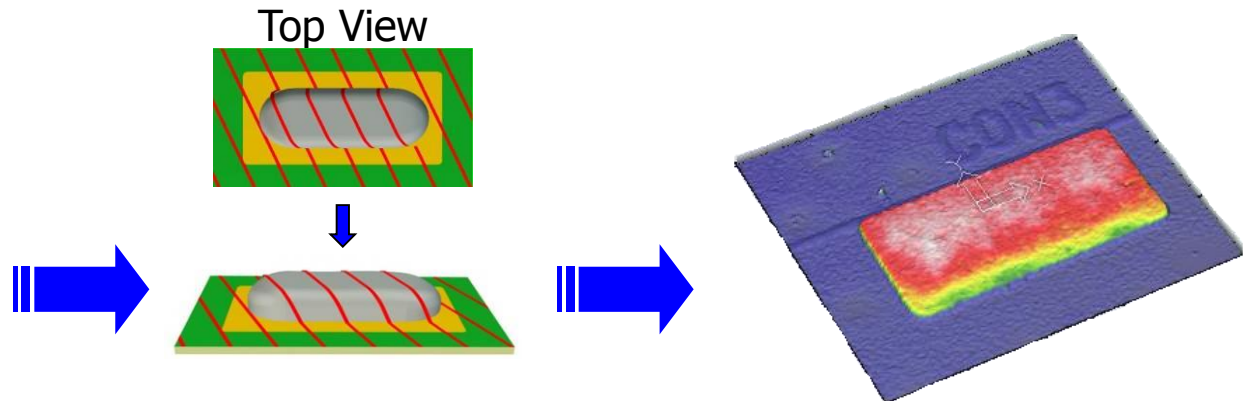
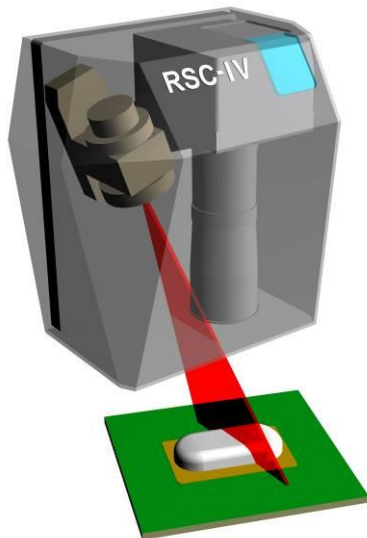
Outstanding Performance

3D Images of Components

3D Images of Panels



RSC IV



- Support 2D & 3D image mode
 - 2D mode : get fiducial mark image
 - 3D mode : get 3D data (height map) for inspection
- Measuring principle
 - Optical triangulation
 - Light source : Laser sheet beam
 - Detector : Ultra high speed camera

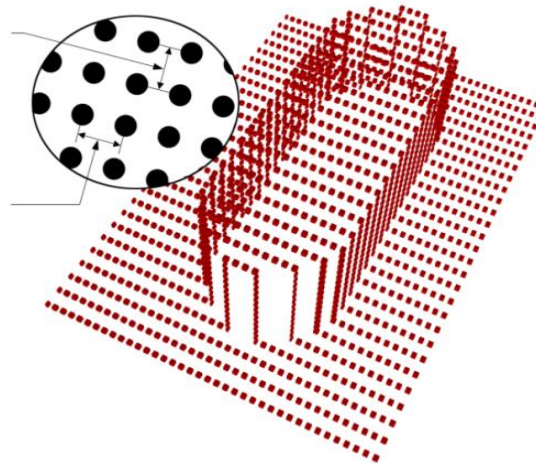


Outstanding Performance

- **High accuracy** - reliable laser beam centroid finding algorithm
- **Most robust** - immune to color, surface finishing variation, and ambient noise
- **Sheet beam not perpendicular to scan direction** - better accuracy
- **Utmost speed** 30 cm²/sec

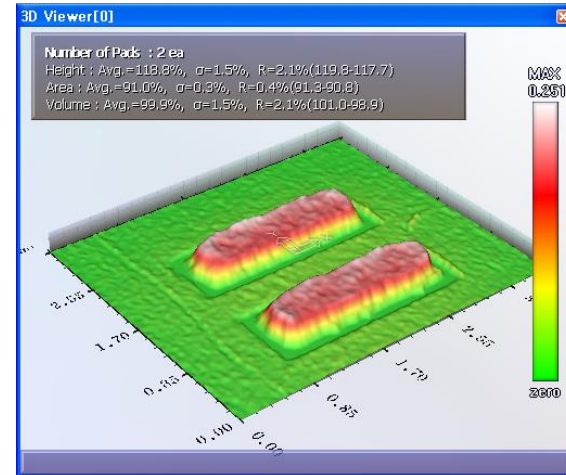
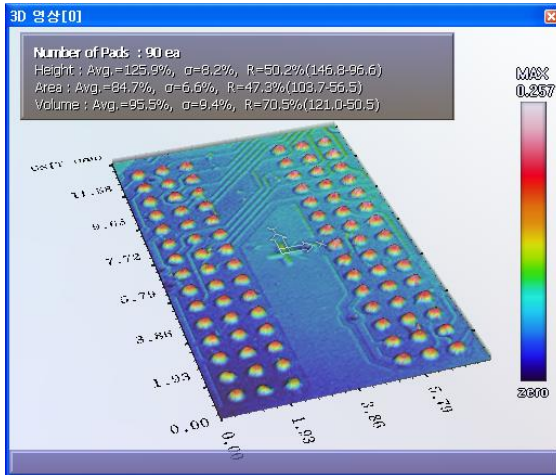
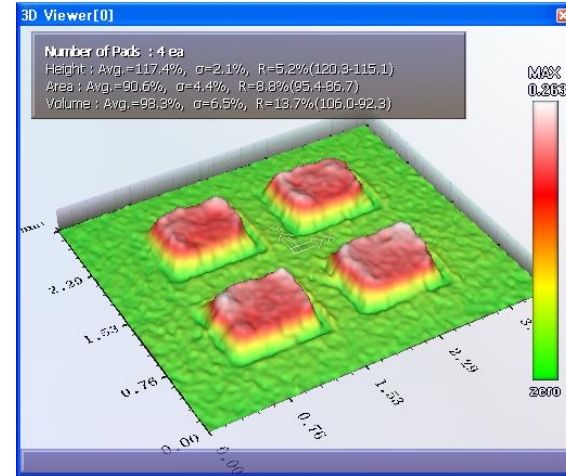
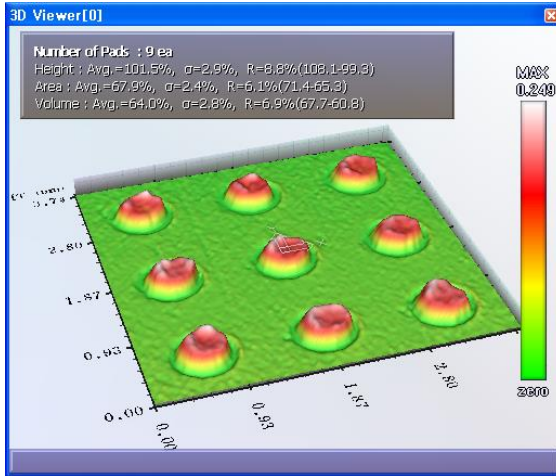
Scan interval

Spatial resolution



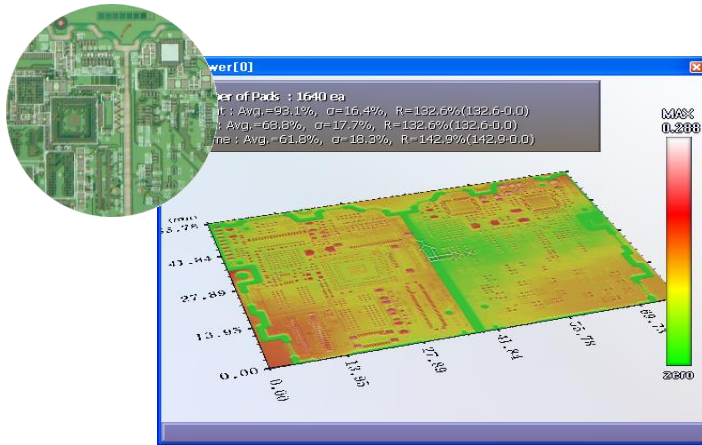


3D Images of Components

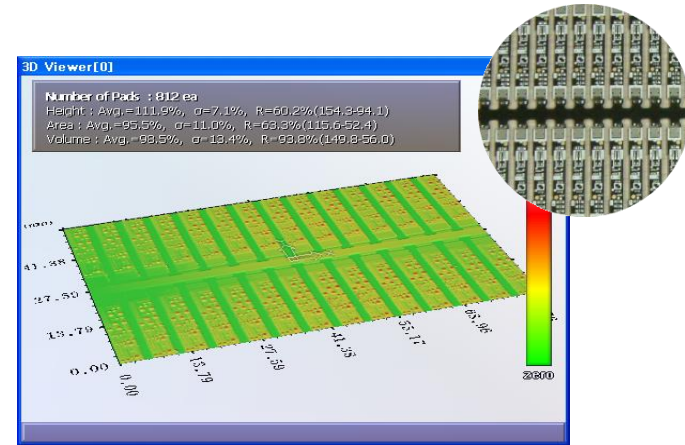




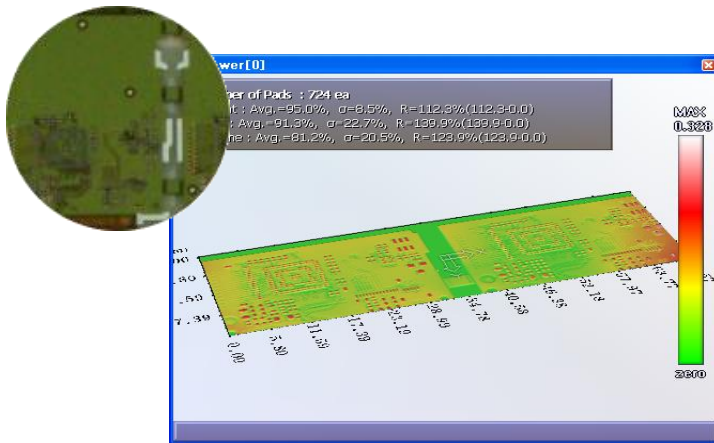
3D Images of Panels



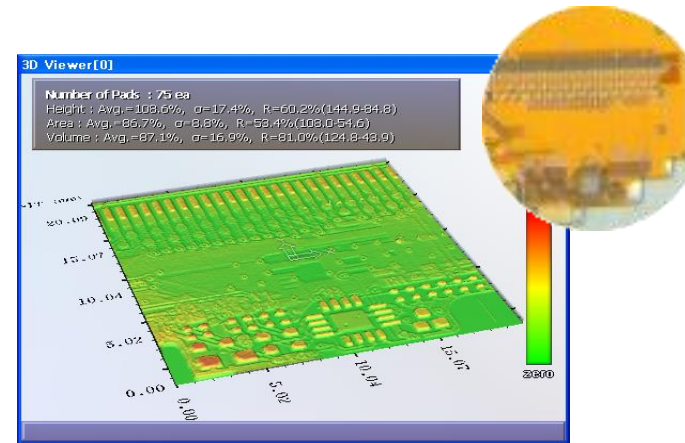
Green Board



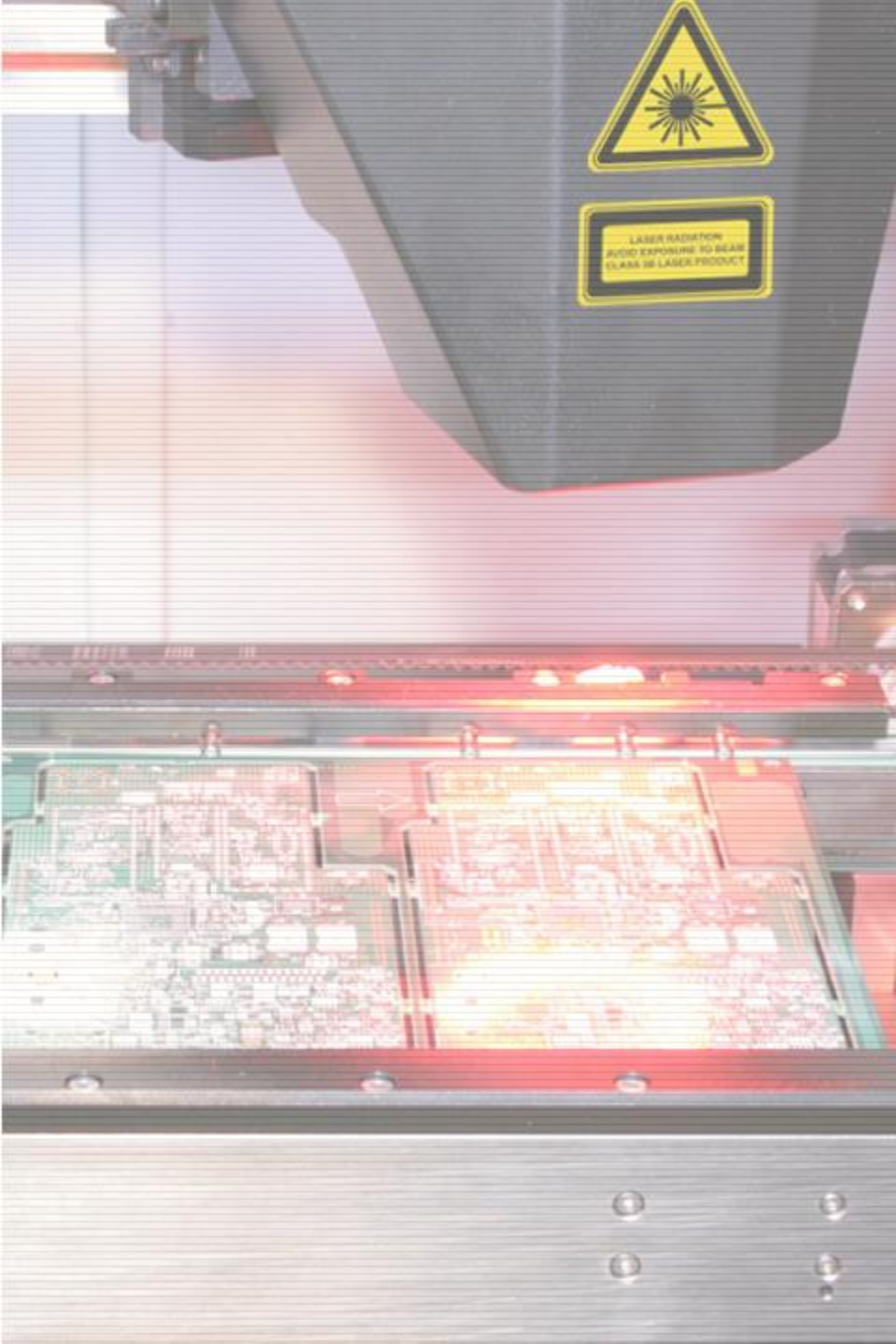
Black Board (Flexible 0.7t)



Dark Green Board (Flexible 0.4t)



Light Yellow Board (Flexible 0.4t)



Operation Software

Software for panel inspection

Summary of SPIworks

Summary of ePm-SPI

Summary of SPCworks



Software for panel inspection



SPIworks
Inspection program



SPCworks
SPC program



ePm-SPI
Teaching program



Summary of SPIworks

- **Machine control & Operator interface**
- **3D Measuring and defect detection**
- **Data save and administration**
- **Process monitoring & control functions**
 - Printing status display by value, sigma, fault frequency coloring
 - 3D shape viewer
 - Measured data viewer
 - Defect viewer for current PCB
 - Defect reviewer for the past NG PCBs
 - X-bar & variance chart





Summary of ePm-SPI

- **Generates output file used by Inspection program (SPIworks)**
- **Output file contains inspection specific info and parameters**
- **Supporting the multi Gerber teaching(Layer Concept)**
- **Inputs : Stencil gerber, CAD X-Y, Mentor Neutral, ECAD Design, FABmaster Pin Cad, ODB++(Optional), BOM files**
- **Supporting the Polygon type of pads & rotated pads**
- **Off-line or on-line programming available**
- **Easy and fast teaching : 10 ~ 20 minutes**

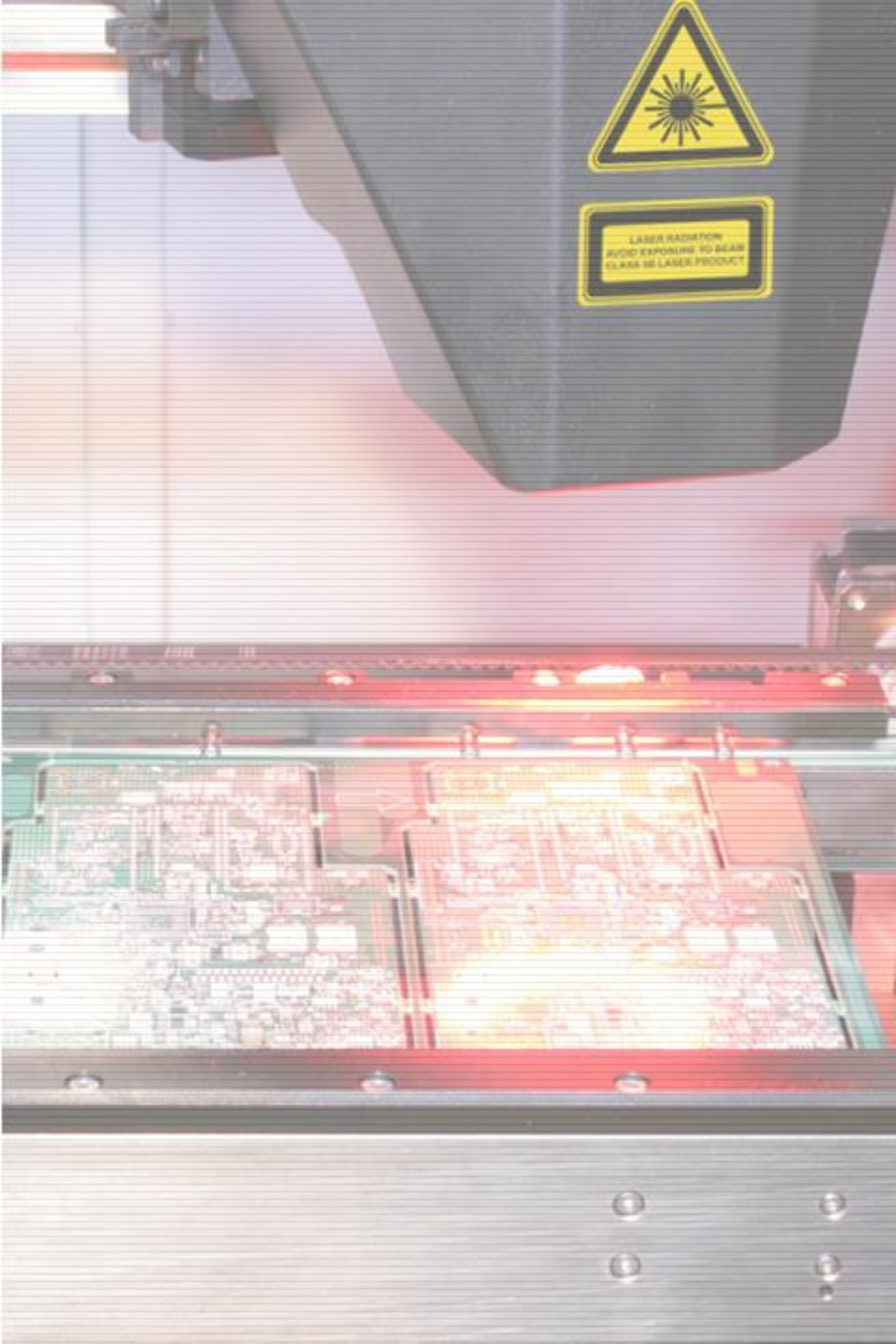




Summary of SPCworks™

- **Statistical process control for solder paste printing process**
 - Monitoring printing process in real time
 - Guide to secure better quality of printed paste
- **Access the SQL data base**
 - Networked application
 - Huge DB with backup function
- **Data analysis**
 - Height, Area, Volume, Offset
 - Control charts and process capability analysis
 - Reporting





SPECIFICATIONS

Functionality & Measurement

Inspection Performance

Board Specification

Hardware System & Interface



Functionality & Measurement

Functionality

Measuring Principal	Laser Optical Triangulation
Paste Type Supported	All (Pb or Pb Free)
Board Type Supported	All colors and All pad finishes
Offline Teaching	ePm-SPI & GerberWorks
SPC & Process Monitoring	SPCworks & RMCworks
System Diagnosis	SPImanager

Measurement

Camera system	High frame rate sensor, 18x18 μm pixel resolution
Scan Resolution	20 μm
Lateral Resolution	18 μm
Optical Layout	Laser with 18° angle
Height Resolution	0.2 μm
Max. Paste Height	1,000 μm
Max. Paste Size	20 x 20 mm



Inspection Performance

Inspection Performance

Inspection Type	Height, Area, Volume, Offset, Bridge
Inspection Speed	30 cm² /sec
Height Repeatability	3 Sigma < 1.0 μm, on a certification target
Area Repeatability	3 Sigma < 1%, on a certification target
Volume Repeatability	3 Sigma < 1%, on a certification target
Height Accuracy	3 μm, on a certification target
Gage R&R	Less than 10 %



Board Specification

Board

Maximum Board Size	370 x 250 mm
Minimum Board Size	50 x 50 mm
Maximum Board Weight	0.7 Kg
Maximum Board Warp	± 3 mm
Board Thickness	0.4 to 4 mm
Board Edge Clearance (Top/Bottom)	4.0 / 4.0 mm
Underside Clearance	16 mm
Topside Clearance	20 mm



Hardware System & Interface

Hardware System

Dimension (W X D X H)	760 X 927 X 578 mm
Weight	110Kg
X-Y robot	Linear motor driven X,Y-stages
Computer	Pentium Core II Duo Processor 4GB Memory
Operating System	Windows XP Professional
Display	17" LCD
Input	Mouse, Keyboard
Supplies	AC 220/230V±10%, 50/60Hz

Interface

Data Input Type	Gerber (RS-274X, RS-274D)
Barcode (option)	1D, 2D